

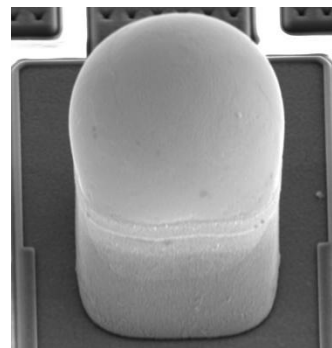
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KYZEN Cleaning Experts to Spotlight MICRONOX Line at SMTA Wafer-Level Packaging Symposium

NASHVILLE — February 2026 — KYZEN, the global leader in innovative environmentally responsible cleaning chemistries, will exhibit at the SMTA Wafer-Level Packaging Symposium scheduled to take place February 17-19 at the Hyatt Regency San Francisco Airport in Burlingame, CA. Scott Cain of KYZEN's Clean Team will be on-site to provide information about KYZEN's advanced packaging cleaning chemistries MICRONOX MX2708, MX2123, and MX2127.

KYZEN cleaning chemistries, including those from the [MICRONOX](#) product line, reflect a commitment to continuous improvement and providing critical cleaning of advanced packaging devices and power electronics.

[MICRONOX MX2708](#) is an organic acid residue cleaning agent offering superior removal of organic acid residues of all kinds within low standoff gaps and fine pitches common on Cu Pillar flip chips, 2.5D/3D ICs, SiP and AiP devices. M2708 cleans most effectively at low concentrations in spray-in-air systems and has no effect on exposed metal and intermetallic alloys.



[MICRONOX MX2123](#) is an aqueous, multi-phase chemistry designed to remove flux residues from all types of IGBT module devices in in-line SIA or ultrasonic immersion cleaning systems. MX2123 leaves ideal surface conditions after cleaning for post wire bond and potting processes while the chemistry's low alkalinity and corrosion inhibition technology protect exposed metal from cleaning agent attack.

[MICRONOX MX2127](#) is an aqueous, single-phase chemistry for removing lead-free and no-clean flux residues from all types of IGBT module devices using copper and nickel DBC substrates. Designed for in-line SIA cleaning systems, MX2127 also provides ideal post-cleaning surface conditions for post wire bond and potting processes, leaving a shiny aluminum bond pad and DBC surface.

KYZEN proudly provides effective cleaning solutions and technical expertise for a variety of challenges in the production of advanced packaging devices and power electronics. For more information about SMTA Wafer-Level Packaging Symposium, [click here](#).

About KYZEN

KYZEN is a global leader in providing environmentally responsible, RoHS compliant precision cleaning chemistries for industries ranging from electronics and advanced packaging to metal finishing and aerospace applications. Since its founding in 1990, KYZEN's innovative cleaning technologies, scientific expertise and customer support have been repeatedly recognized with the industry's most prestigious awards. For more information, visit www.kyzen.com.